

1508.63671

PATENT APPLICATION

3/a 9.23w  
G. Cor

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re U.S. Patent Application )

Applicant: Shigeru Okamoto )

Divisional of: )

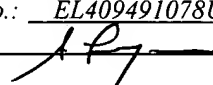
Serial No. 08/959,763 )

Filed: October 29, 1997 )

For: EMBEDDED ELECTROCONDUCTIVE LAYER AND METHOD FOR FORMATION THEREOF )

Examiner: Eaton, K. )

Art Unit: 2823 )

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F-CLASS.WCM  
Appr. February 20, 1998

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

Prior to examination on the merits, please amend the above-identified application as follows: